

ISP1520

Hi-Speed Universal Serial Bus hub controller

Rev. 01 — 25 June 2003

Preliminary data



1. General description

The ISP1520 is a stand-alone Universal Serial Bus (USB) hub controller IC that complies with *Universal Serial Bus Specification Rev. 2.0.* It supports data transfer at high-speed (480 Mbit/s), full-speed (12 Mbit/s) and low-speed (1.5 Mbit/s).

The upstream facing port can be connected to a Hi-Speed USB host or hub or to an Original USB host or hub. If the upstream facing port is connected to a Hi-Speed USB host or hub, then the ISP1520 will operate as a Hi-Speed USB hub. That is, it will support high-speed, full-speed and low-speed devices connected to its downstream facing ports. If the upstream facing port is connected to an Original USB host or hub, then the ISP1520 will operate as an Original USB hub. That is, high-speed devices that are connected to its downstream facing ports will operate in full-speed mode instead.

The ISP1520 is a full hardware USB hub controller. All Original USB devices connected to the downstream facing ports are handled using a single Transaction Translator (TT), when operating in a cross-version environment. This allows the whole 480 Mbit/s upstream bandwidth to be shared by all the Original USB devices on its downstream facing ports.

The ISP1520 has four downstream facing ports. If not used, ports 3 and 4 can be disabled. The vendor ID, product ID and string descriptors on the hub are supplied by the internal ROM; they can also be supplied by an external I²C-bus[™] EEPROM or a microcontroller.

The ISP1520 IC is suitable for self-powered, bus-powered or hybrid-powered hub designs.

An analog overcurrent detection circuitry is built into the ISP1520, which can also accept digital overcurrent signals from external circuits; for example, Micrel MOSFET switch MIC2026. The circuitry can be configured to trip on a global or an individual overcurrent condition.

Each port comes with two status indicator LEDs.

Target applications of the ISP1520 are monitor hubs, docking stations for notebooks, internal USB hub for motherboards, hub for extending Intel[®] Easy PCs, hub boxes, and so on.



2. Features

- Complies with:
 - Universal Serial Bus Specification Rev. 2.0
 - Advanced Configuration and Power Interface (ACPI™), OnNow™ and USB power management requirements.
- Supports data transfer at high-speed (480 Mbit/s), full-speed (12 Mbit/s) and low-speed (1.5 Mbit/s)
- Bus-powered or self-powered capability
- USB suspend mode support
- Configurable number of ports
- Internal power-on reset and low voltage reset circuit
- Port status indicators
- Integrates high performance USB interface device with hub handler, Philips Serial Interface Engine (SIE) and transceivers
- Built-in overcurrent detection circuit
- Individual or ganged power switching, individual or global overcurrent protection, and non-removable port support by I/O pins configuration
- Simple I²C-bus (master/slave) interface to read device descriptor parameters, language ID, manufacturer ID, product ID, serial number ID and string descriptors from a dedicated external EEPROM, or to allow the microcontroller to set up hub descriptors
- Visual USB traffic monitoring (GoodLink™) for the upstream facing port
- Uses 12 MHz crystal oscillator with on-chip Phase-Locked Loop (PLL) for low ElectroMagnetic Interference (EMI)
- Full industrial operating temperature range from –40 to +85 °C
- Available in LQFP64 package.

3. Applications

- Monitor hubs
- Docking stations for notebooks
- Internal hub for USB motherboards
- Hub for extending Easy PCs
- Hub boxes.

4. Abbreviations

- ACPI Advanced Configuration and Power Interface
- EMI ElectroMagnetic Interference
- **ESD** ElectroStatic Discharge
- **NAK** Not AcKnowledge
- PID Packet Identifier
- PLL Phase-Locked Loop
- SIE Serial Interface Engine
- TT Transaction Translator
- **USB** Universal Serial Bus.

5. Ordering information

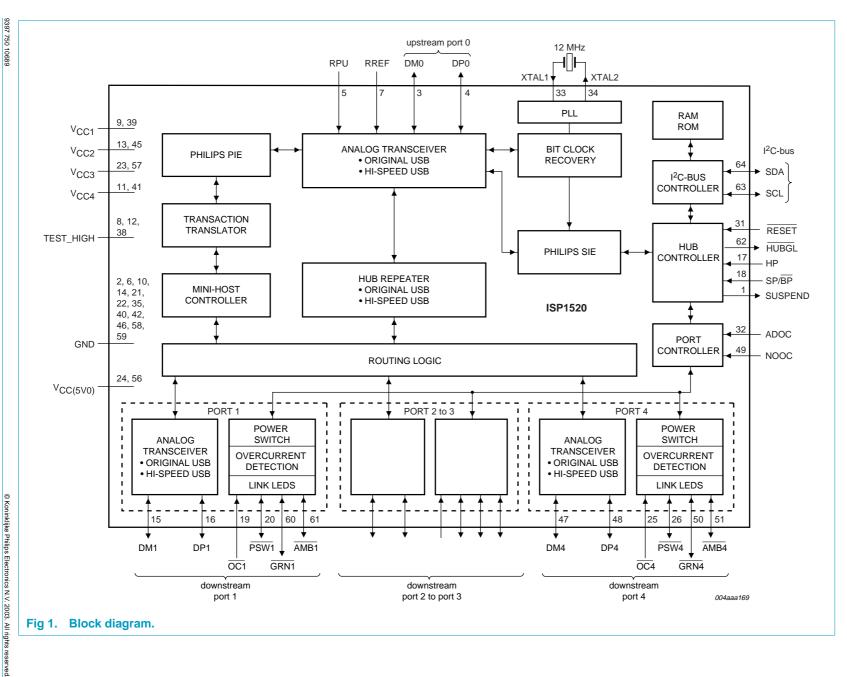
Table 1:Ordering information

Type number	Package				
	Name	Description	Version		
ISP1520BD	LQFP64	plastic low profile quad flat package; 64 leads; body $10 \times 10 \times 1.4$ mm	SOT314-2		



SP1520

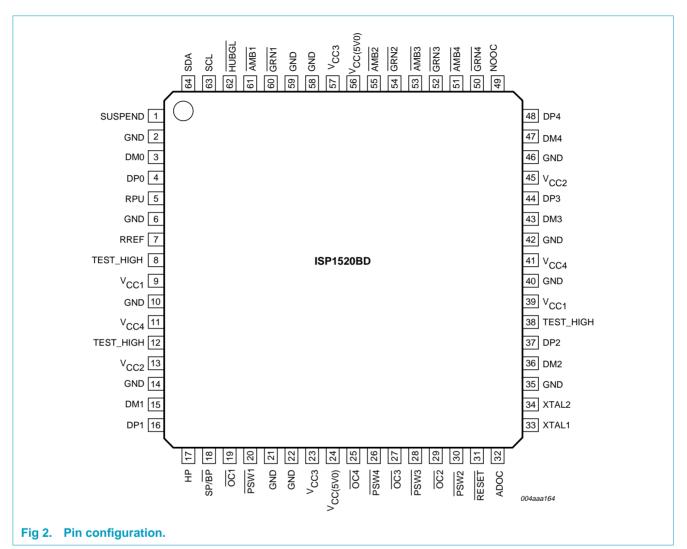
6. Block diagram



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7. Pinning information

7.1 Pinning



7.2 Pin description

Table 2: Pi	n descr	iption	
Symbol ^[1]	Pin	Туре	Description
SUSPEND	1	0	suspend indicator output; HIGH indicates that the hub is in the suspend mode
GND	2	-	ground supply
DM0	3	AI/O	upstream facing port D- connection (analog)
DP0	4	AI/O	upstream facing port D+ connection (analog)
RPU	5	AI	pull-up resistor connection; connect this pin through a resistor of 1.5 k $\Omega\pm5\%$ to 3.3 V
GND	6	-	ground supply

	Pin	iptiona	
Symbol ^[1]		Туре	Description
RREF	7	AI	reference resistor connection; connect this pin through a resistor of 12 k $\Omega\pm$ 1% to an analog band gap ground reference
TEST_HIGH	8	-	test pin; connect to 3.3 V
V _{CC1}	9	-	analog supply voltage 1 (3.3 V)
GND	10	-	ground supply
V _{CC4}	11	-	crystal and PLL supply voltage 4 (3.3 V)
TEST_HIGH	12	-	test pin; connect to 3.3 V
V _{CC2}	13	-	transceiver supply voltage 2 (3.3 V)
GND	14	-	ground supply
DM1	15	AI/O	downstream facing port 1 D– connection (analog) ^[2]
DP1	16	AI/O	downstream facing port 1 D+ connection (analog) ^[2]
HP	17	I	hybrid-powered operation selection input; connect this pin to upstream facing V_{BUS} for the hybrid-powered operation; for pure self-powered or bus-powered operation, connect this pin to GND; see Table 4
SP/BP	18	I	self-powered or bus-powered operation selection input:
			self-powered (or hybrid-powered) operation — connect this pin to the 5 V local power supply (HIGH); in the hybrid-powered operation, this pin acts as a local power supply good or loss indication
			bus-powered operation — connect this pin to GND; downstream facing ports 3 to 4 are automatically disabled
OC1	19	Al/I	overcurrent sense input for downstream facing port 1 (analog/digital)
PSW1	20	I/O	output — power switch control output (open-drain) with an internal pull-up resistor for downstream facing port 1
			input — function of the pin when used as an input is given in Table 6
GND	21	-	ground supply
GND	22	-	ground supply
V _{CC3}	23	-	digital supply voltage 3 (3.3 V)
V _{CC(5V0)}	24	-	downstream facing ports supply voltage (5 V \pm 5%); used to power internal pull-up resistors of PSWn pins and as a reference voltage for the analog overcurrent detection
OC4	25	AI/I	overcurrent sense input for downstream facing port 4 (analog/digital)
PSW4	26	I/O	output — power switch control output (open-drain) with an internal pull-up resistor for downstream facing port 4
			input — function of the pin when used as an input is given in Table 6
OC3	27	AI/I	overcurrent sense input for downstream facing port 3 (analog/digital)

Table 2: Pir	n descr	iptiona	continued	
Symbol ^[1]	Pin	Туре	Description	
PSW3	28	I/O	output — power switch control output (open-drain) with an internal pull-up resistor for downstream facing port 3	
			input — function of the pin when used as an input is given in Table 6	
OC2	29	AI/I	overcurrent sense input for downstream facing port 2 (analog/digital)	
PSW2	30	I/O	output — power switch control output (open-drain) with an internal pull-up resistor for downstream facing port 2	
			input — function of the pin when used as an input is given in Table 6	
RESET	31	I	asynchronous reset input; when reset is active, the internal switch to the 1.5 k Ω external resistor is opened, and all pins DPn and DMn are three-state; it is recommended to connect to V _{BUS} through an RC circuit; refer to the schematics in the <i>ISP1520 Hub Demo Board User's Guide</i>	
ADOC	32	I	analog or digital overcurrent detect selection input; a LOW selects the digital mode and a HIGH (3.3 V) selects the analog mode	
XTAL1	33	I	crystal oscillator input (12 MHz)	
XTAL2	34	0	crystal oscillator output (12 MHz)	
GND	35	-	ground supply	
DM2	36	AI/O	downstream facing port 2 D- connection (analog) ^[2]	
DP2	37	AI/O	downstream facing port 2 D+ connection (analog) ^[2]	
TEST_HIGH	38	-	test pin; connect to 3.3 V	
V _{CC1}	39	-	analog supply voltage 1 (3.3 V)	
GND	40	-	ground supply	
V _{CC4}	41	-	crystal and PLL supply voltage 4 (3.3 V)	
GND	42	-	ground supply	
DM3	43	AI/O	downstream facing port 3 D– connection (analog) ^[3]	
DP3	44	AI/O	downstream facing port 3 D+ connection (analog) ^[3]	
V _{CC2}	45	-	transceiver supply voltage 2 (3.3 V)	
GND	46	-	ground supply	
DM4	47	AI/O	downstream facing port 4 D– connection (analog) ^[3]	
DP4	48	AI/O	downstream facing port 4 D+ connection (analog) ^[3]	
NOOC	49	Ι	no overcurrent protection selection input; connect this pin to HIGH (3.3 V) to select no overcurrent protection; if no overcurrent is selected, all \overline{OCn} pins must be connected to $V_{CC(5V0)}$	
GRN4	50	I/O	output — green LED port indicator (open-drain) for downstream facing port 4	
			input — function of the pin when used as an input is given in Table 10	

	in descr	iption	continued
Symbol ^[1]	Pin	Туре	Description
AMB4	51	I/O	output — amber LED port indicator (open-drain) for downstream facing port 4
			input — function of the pin when used as an input is given in Table 9
GRN3	52	I/O	output — green LED port indicator (open-drain) for downstream facing port 3
			input — function of the pin when used as an input is given in Table 10
AMB3	53	I/O	output — amber LED port indicator (open-drain) for downstream facing port 3
			input — function of the pin when used as an input is given in Table 9
GRN2	54	I/O	output — green LED port indicator (open-drain) for downstream facing port 2
			input — function of the pin when used as an input is given in Table 10
AMB2	55	I/O	output — amber LED port indicator (open-drain) for downstream facing port 2
			input — function of the pin when used as an input is given in Table 9
V _{CC(5V0)}	56	-	downstream facing ports supply voltage (5 V \pm 5%); used to power internal pull-up resistors of $\overline{\text{PSWn}}$ pins and as a reference voltage for the analog overcurrent detection
V _{CC3}	57	-	digital supply voltage 3 (3.3 V)
GND	58	-	ground supply
GND	59	-	ground supply
GRN1	60	I/O	output — green LED port indicator (open-drain) for downstream facing port 1
			input — function of the pin when used as an input is given in Table 10
AMB1	61	I/O	output — amber LED port indicator (open-drain) for downstream facing port 1
			input — function of the pin when used as an input is given in Table 9
HUBGL	62	0	hub GoodLink LED indicator output; the LED is off until the hub is configured; a transaction between the host and the hub will blink the LED off for 100 ms; this LED is off in the suspend mode (open-drain)
SCL	63	I/O	I ² C-bus clock (open-drain); see Table 12
SDA	64	I/O	I ² C-bus data (open-drain); see Table 12

[1] Symbol names with an overscore (for example, NAME) represent active LOW signals.

[2] Downstream ports 1 and 2 cannot be disabled.

[3] To disable a downstream port n, connect both pins DPn and DMn to V_{CC} (3.3 V); unused ports must be disabled in reverse order starting from port 4.

8. Functional description

8.1 Analog transceivers

The integrated transceivers directly interface to USB lines. They are capable of transmitting and receiving serial data at high-speed (480 Mbit/s), full-speed (12 Mbit/s) and low-speed (1.5 Mbit/s).

8.2 Hub controller core

The main components of the hub core are:

- Philips Serial Interface Engine (SIE)
- Routing logic
- Transaction Translator (TT)
- Mini-host controller
- Hub repeater
- Hub controller
- Port controller
- Bit clock recovery.

8.2.1 Philips serial interface engine

The Philips SIE implements the full USB protocol layer. It is completely hardwired for speed and needs no firmware intervention. The functions of this block include: synchronization, pattern recognition, parallel or serial conversion, bit (de-)stuffing, CRC checking and generation, Packet IDentifier verification and generation, address recognition, and handshake evaluation and generation.

8.2.2 Routing logic

The routing logic directs signaling to the appropriate modules (mini-host controller, Original USB repeater and Hi-Speed USB repeater, according to the topology in which the hub is placed.

8.2.3 Transaction translator

The TT acts as a go-between mechanism that links devices operating in the Original USB mode and the Hi-Speed USB upstream mode. For the 'in' direction, data is concatenated in TT buffers till the proper length is reached, before the host takes the transaction. In the reverse direction (out), the mini-host dispenses the data contained in TT buffers over a period that fits into the Original USB bandwidth. This continues until all outgoing data is emptied. TT buffers are used only on split transactions.

8.2.4 Mini-host controller

The internal mini-host generates all the Original USB IN, OUT or SETUP tokens for the downstream facing ports, while the upstream facing port is in the high-speed mode. The responses from the Original USB devices are collected in TT buffers, until the end of the complete split transaction clears the TT buffers.

8.2.5 Hub repeater

A hub repeater is responsible for managing connectivity on a per packet basis. It implements packet signaling connectivity and resume connectivity. There are two repeaters in the ISP1520: a Hi-Speed USB repeater and a Original USB repeater. The only major difference between these two repeaters is the speed at which they operate. When the hub is connected to an Original USB system, it automatically switches itself to function as a pure Original USB hub.

8.2.6 Hub and port controller

The hub controller provides status report. The port controller provides control for individual downstream facing port; it controls the port routing module. Any port status change will be reported to the host via the hub status change (interrupt) endpoint.

8.2.7 Bit clock recovery

The bit clock recovery circuit extracts the clock from the incoming USB data stream.

8.3 Phase-locked loop clock multiplier

A 12 to 480 MHz clock multiplier PLL is integrated on-chip. This allows the use of low-cost 12 MHz crystals. The low crystal frequency also minimizes ElectroMagnetic Interference (EMI). No external components are required for the operation of the PLL.

8.4 l²C-bus controller

A simple serial I²C-bus interface is provided to transfer vendor ID, product ID and string descriptor from an external I²C-bus EEPROM (for example, Philips PCF8582 or equivalent) or microcontroller. A master/slave I²C-bus protocol is implemented according to the timing requirements as mentioned in the I²C-bus standard specifications. The maximum data count during I²C-bus transfers for the ISP1520 is 256 bytes.

8.5 Overcurrent detection circuit

An overcurrent detection circuit is integrated on-chip. The main features of this circuit are: self reporting, automatic resetting, low-trip time and low cost. This circuit offers an easy solution at no extra hardware cost on the board.

8.6 GoodLink

Indication of a good USB connection is provided through GoodLink technology. An LED can be directly connected to pin $\overline{\text{HUBGL}}$ via an external 330 Ω resistor.

During enumeration, the LED blinks on momentarily. After successful configuration, the LED blinks off for 100 ms upon each transaction.

This feature provides a user-friendly indication of the status of the hub, the connected downstream devices and the USB traffic. It is a useful diagnostics tool to isolate faulty USB equipment and helps to reduce field support and hotline costs.

8.7 Power switch and hub power modes

USB hubs can either be self-powered or bus-powered.

Self-powered — Self-powered hubs have a 5 V local power supply on board that provides power to the hub and the downstream ports. The *Universal Serial Bus Specification Rev. 2.0* requires that these hubs limit current to 500 mA per downstream port and report overcurrent conditions to the host.

Bus-powered — Bus-powered hubs obtain all power from the host or an upstream self-powered hub. The maximum current is 100 mA per downstream port. Current limiting and reporting of overcurrent conditions are both optional.

Hybrid powered — As an option, the hub may draw current from the USB supply (V_{BUS}) to power the interface functions.

Power switching of downstream ports can be done **individually** or **ganged**, where all ports are simultaneously switched with one power switch. The ISP1520 supports both modes, which can be selected using input PSWn; see Table 6.

8.7.1 Voltage drop requirements

Self-powered: Self-powered hubs are required to provide a minimum of 4.75 V to its output port connectors at all legal load conditions. To comply with Underwriters Laboratory Inc. (UL) safety requirements, the power from any port must be limited to 25 W (5 A at 5 V). Overcurrent protection may be implemented on a global or individual basis.

Assuming a 5 V \pm 3% power supply, the worst-case supply voltage is 4.85 V. This only allows a voltage drop of 100 mV across the hub Printed-Circuit Board (PCB) to each downstream connector. This includes a voltage drop across the:

- Power supply connector
- Hub PCB (power and ground traces, ferrite beads)
- Power switch (FET on-resistance)
- Overcurrent sense device.

The PCB resistance and power supply connector resistance may cause a drop of 25 mV, leaving only 75 mV as the voltage drop allowed across the power switch and overcurrent sense device. The individual voltage drop components are shown in Figure 3.

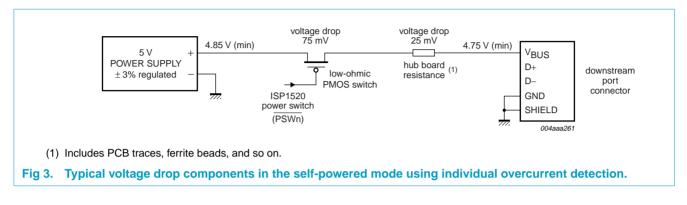
For global overcurrent detection, an increased voltage drop is needed for the overcurrent sense device (in this case, a low-ohmic resistor). This can be realized by using a special power supply of 5.1 V \pm 3%, as shown in Figure 4.

Bus-powered: Bus-powered hubs are guaranteed to receive a supply voltage of 4.5 V at the upstream port connector and must provide a minimum of 4.4 V to the downstream port connectors. The voltage drop of 100 mV across bus-powered hubs include:

- Hub PCB (power and ground traces, ferrite beads)
- Power switch (FET on-resistance)
- Overcurrent sense device.

ISP1520

The PCB resistance may cause a drop of 25 mV, which leaves 75 mV for the power switch and overcurrent sense device. The voltage drop components are shown in Figure 5. For bus-powered hubs, overcurrent protection is optional. It may be implemented for all downstream ports on a global or an individual basis.



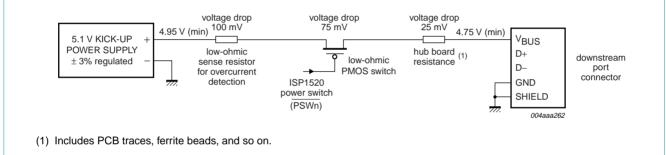
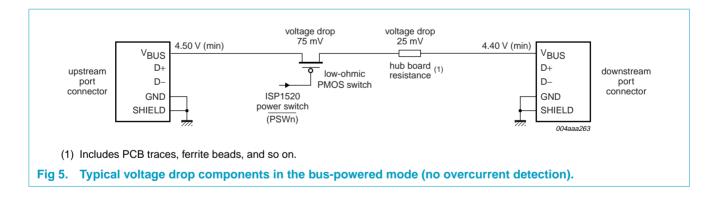


Fig 4. Typical voltage drop components in the self-powered mode using global overcurrent detection.



9. Configuration selections

The ISP1520 is configured through I/O pins and, optionally, through an external I^2C -bus, in which case the hub can update its configuration descriptors as a master or as a slave.

Table 3 shows the configuration parameters.

Table 3: Configuration parameters							
Mode and selection	Option	Configuration method					
		Pin control		Software control			
		Control pin	Reference	Affected field	Reference		
Hub power operating	self-powered	HP and SP/BP	see Section 9.1.1	bmAttributes	see Table 19		
mode	hybrid-powered bus-powered			MaxPower: maximum bus power	see Table 19		
Number of downstream facing ports	2 ports 3 ports 4 ports	DM1/DP1 to DM4/DP4	see Section 9.1.2	bNbrPorts0: in bus-powered mode only 2 ports	see Table 23		
Power switching mode	ganged multiple ganged ^[1]	PSW1 to PSW4	see Section 9.1.3	wHubCharacteristics: bits D1 and D0	see Table 23		
	individual			bPwrOn2PwrGood: time interval			
Overcurrent protection mode	none global ^[2] multiple ganged individual	NOOC and OC1 to OC4	see Section 9.1.4	wHubCharacteristics: bits D4 and D3	see Table 23		
Non-removable ports	any port can be non-removable	AMBn	see Section 9.1.5	wHubCharacteristics: bit D2 (compound hub)	see Table 23		
				DeviceRemovable: bit map			
Port indicator support	no yes	all GRNn	see Section 9.1.6	wHubCharacteristics: bit D7	see Table 23		

[1] Multiple ganged power mode is reported as individual power mode; refer to the USB 2.0 specification.

[2] When the hub uses the global overcurrent protection mode, the overcurrent indication is through the wHubStatus field bit 1 (overcurrent) and the corresponding change bit (overcurrent change).

9.1 Configuration through I/O pins

9.1.1 Hub power operating modes

Table 4 lists all possible combinations of the hub power operating mode.

Bus-powered operation — connect pins HP and SP/BP to ground; downstream facing ports 3 to 4 are automatically disabled.

Self-powered operation — connect pin HP to ground and pin SP/BP to 5 V.

Hybrid powered operation — connect pin HP to upstream facing V_{BUS} ; pin SP/ \overline{BP} acts as a local power supply good (HIGH) or loss (LOW) indication.

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HP	SP/BP	Hub power operating mode
LOW	LOW	bus-powered
LOW	HIGH	self-powered
HIGH	LOW	hybrid-powered (local power loss)
HIGH	HIGH	hybrid-powered (local power good)

Table 4: Hub power operating mode pin configuration

9.1.2 Number of downstream facing ports

To discount a physical downstream facing port, connect pins DP and DM of that downstream facing port to V_{CC} (3.3 V) starting from the highest port number (4); see Table 5.

The sum of physical ports configured is reflected in the bNbrPorts field.

In the bus-powered mode, the ISP1520 has only two enabled downstream facing ports because of USB power considerations.

Number of physical downstream facing port	DM1/DP1	DM2/DP2	DM3/DP3	DM4/DP4		
4	15 kΩ pull-down	15 kΩ pull-down	15 kΩ pull-down	15 kΩ pull-down		
3	15 kΩ pull-down	15 kΩ pull-down	15 kΩ pull-down	V _{CC}		
2	15 kΩ pull-down	15 kΩ pull-down	V _{CC}	V _{CC}		

Table 5: Downstream facing port number pin configuration

9.1.3 Power switching modes

Table 6 lists the power switching mode configuration.

PSWn pins have integrated weak pull-up resistors inside the chip.

Table 6: Power Switchin	ig mode: pin o	configuration		
Power switching mode	PSW1	PSW2	PSW3	PSW4
Ganged	internal pull-up	ground	ground	ground
Individual	internal pull-up	internal pull-up	internal pull-up	internal pull-up

Table 6: Power switching mode: pin configuration

9.1.4 Overcurrent protection mode

The ISP1520 supports all overcurrent protection modes: none, global, individual and multiple ganged.

No overcurrent protection mode reporting is selected when pin NOOC = HIGH. Global, individual and multiple ganged overcurrent protection modes are selected using pins \overline{PSWn} , following the power switching modes selection scheme; see Table 7.

For the ganged overcurrent protection mode, the descriptor reports global overcurrent protection. Only $\overline{PSW1}$ and $\overline{OC1}$ are active; i.e. in the ganged mode, the remaining power switch pins and the overcurrent indicator pins are disabled. To inhibit the analog overcurrent detection, the \overline{OC} pins must be connected to $V_{CC(5V0)}$.

Power switching mode	NOOC	PSW1	PSW2	PSW3	PSW4
Ganged	LOW	internal pull-up	ground	ground	ground
Individual	LOW	internal pull-up	internal pull-up	internal pull-up	internal pull-up

Table 7: Overcurrent protection mode pin configuration

Both analog and digital overcurrent modes are supported; see Table 8.

For digital overcurrent detection, the normal digital TTL level is accepted on the overcurrent input pins. For analog overcurrent detection, the threshold is given in the DC characteristics. In this mode, to filter out false overcurrent conditions because of in rush and spikes, a dead time of 15 ms is built into the IC, that is, overcurrent must persist for 15 ms before it is reported to the host.

Table 8: Overcurrent detection mode selection pin configuration

Pin ADOC	Mode selection	Description
5 V	analog	threshold ΔV_{trip}
Ground	digital	normal digital TTL level

9.1.5 Non-removable port

A non-removable port, by definition, is a port that is embedded inside the hub application box and is not accessible externally. The LED port indicators (pins AMBn) of such a port are not used. Therefore, the corresponding amber LED port indicators are disabled to signify that the port is non-removable; see Table 9.

More than one non-removable port can be specified by appropriately connecting the corresponding amber LED indicators. However, at least one port should be left as a removable port.

The detection of any non-removable port sets the hub descriptor into a compound hub.

	-generation
AMBn (n = 1 to 4)	Non-removable port
Ground	non-removable
Pull-up with amber LED	removable

Table 9:	Non-removable	port pin	configuration

9.1.6 Port indicator support

The port indicator support can be disabled by grounding all green port indicators (all pins GRNn); see Table 10. This is a global feature. It is not possible to disable port indicators for only one port.

GRN1 to GRN4	Port indicator support
Ground	not supported
LED pull-up green LED for at least one port	supported

9.2 Device descriptors and string descriptors settings using I²C-bus

9.2.1 Background information on I²C-bus

The I²C-bus is suitable for bi-directional communication between ICs or modules. It consists of two bi-directional lines: SDA for data signals and SCL for clock signals. Both these lines must be connected to a positive supply voltage through a pull-up resistor.

The basic I²C-bus protocol is defined as:

- Data transfer is initiated only when the bus is not busy.
- Changes in the data line occur when the clock is LOW and must be stable when the clock is HIGH. Any changes in data lines when the clock is HIGH will be interpreted as control signals.

Different conditions on I²C-bus: The I²C-bus protocol defines the following conditions:

Not busy — both SDA and SCL remain HIGH

START — a HIGH-to-LOW transition on SDA, while SCL is HIGH

STOP — a LOW-to-HIGH transition on SDA, while SCL is HIGH

Data valid — after a START condition, data on SDA must be stable for the duration of the HIGH period of SCL.

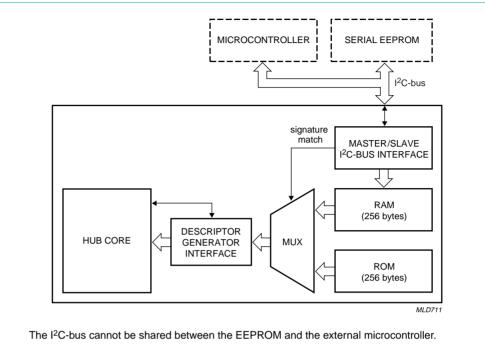
Data transfer: The master initiates each data transfer using a START condition and terminates it by generating a STOP condition. To facilitate the next byte transfer, each byte of data must be acknowledged by the receiver. The acknowledgement is done by pulling the SDA line LOW on the ninth bit of the data. An extra clock pulse needs to be generated by the master to accommodate this bit.

For more detailed information on the operation of the bus, refer to *The l²C-bus specification*.

I²C-bus address: The address of the ISP1521 is given in Table 11.

Table 11:I²C-bus slave address

	MSB	Slave address LSB						
Bit	A7	A6	A5	A4	A3	A2	A1	R/W
Value	0	0	1	1	0	1	0	0/1



9.2.2 Architecture of configurable hub descriptors

Fig 6. Configurable hub descriptors.

The configurable hub descriptors can be masked in the internal ROM memory; see Figure 6. These descriptors can also be supplied from an external EEPROM or a microcontroller. The ISP1520 implements both the master and slave I²C-bus controllers. The information from the external EEPROM or the microcontroller is transferred into the internal RAM during the power-on reset. A signature word is used to identify correct descriptors. If the signature matches, the content of the RAM is chosen instead of the ROM.

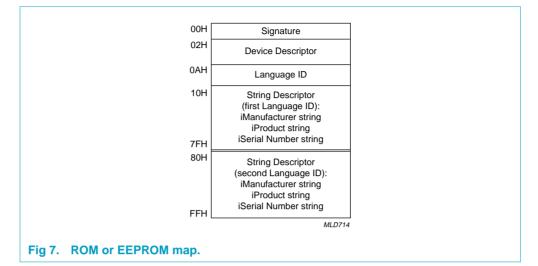
When the external microcontroller mode is selected and while the external microcontroller is writing to the internal RAM, any request to configurable descriptors will be responded to with a NAK (Not AcKnowledge). There is no specified time-out period for the NAK signal. This data is then passed to the host during the enumeration process.

The three configuration methods are selected by connecting pins SCL and SDA in the manner given in Table 12.

Configuration methodSCLSDAInternal ROMgroundgroundExternal EEPROM2.2 to 4.7 kΩ pull-up2.2 to 4.7 kΩ pull-upExternal microcontrollerdriven LOW by the
microcontroller during reset2.2 to 4.7 kΩ pull-up

Table 12: Configuration method

9.2.3 ROM or EEPROM map



Remark: A 128-byte EEPROM supports one language ID only, and a 256-byte EEPROM supports two language IDs.

9.2.4 ROM or EEPROM detailed map

Table 13: ROM or EEPROM detailed map

Address (Hex)	Content	Default (Hex)	Example (Hex)	Comment
Signature	e descriptor			
00	signature (low	55	-	signature to signify valid data comment
01	signature (high)	AA	-	
Device d	escriptor			
02	idVendor (low)	CC	-	Philips Semiconductors vendor ID
03	idVendor (high)	04	-	
04	idProduct (low)	20	-	ISP1520 product ID
05	idProduct (high)	15	-	—
06	bcdDevice (low)	00	-	device release; silicon revision
07	bcdDevice (high)	02	-	increments this value
08	RSV, iSN, iP, iM	-	00	if all the three strings are supported, the value of this byte is 39H
09	reserved	-	FF	-
String de	scriptor Index 0 (la	anguage l	D)	
0A	bLength ^[1]	-	06	two language ID support
0B	bDescriptorType	-	03 <mark>[2]</mark>	STRING
0C	wLANGID[0]	-	09	LANGID code zero (first language ID)
0D		-	04	(English—USA in this example)
0E	wLANGID[1]	-	09	LANGID code one (second language ID)
0F		-	08	(English—UK in this example)

ntent iptor Index 1 (il ength escriptorType tring	Default (Hex) Manufactu - - - - - - - - - - - - - - - - - - -	(Hex)	Comment string descriptor length (manufacturer IE STRING P of Philips h i I p s S of Semiconductors e
ength escriptorType	Manufactu	Irer) ^[3] 2E 03 ^[2] 50 00 68 00 69 00 6C 00 69 00 70 00 73 00 20 00 53 00 65 00	STRING P of Philips h i I I s S of Semiconductors
ength escriptorType	- - - - - - - - - - - - - - -	2E 03 ^[2] 50 00 68 00 69 00 60 00 70 00 73 00 20 00 53 00 65 00	STRING P of Philips h i I I s S of Semiconductors
escriptorType	- - - - - - - - - - - -	03 ^[2] 50 00 68 00 69 00 6C 00 69 00 70 00 73 00 20 00 53 00 65 00	STRING P of Philips h i I I s S of Semiconductors
	- - - - - - - - -	50 00 68 00 69 00 60 00 70 00 73 00 20 00 53 00 65 00	P of Philips h i I i P s S of Semiconductors
	- - - - - - - - -	68 00 69 00 6C 00 70 00 73 00 20 00 53 00 65 00	h i I p s S of Semiconductors
	- - - - -	69 00 6C 00 69 00 70 00 73 00 20 00 53 00 65 00	i I i P s S of Semiconductors
	- - - - -	6C 00 69 00 70 00 73 00 20 00 53 00 65 00	l i p s S of Semiconductors
	-	69 00 70 00 73 00 20 00 53 00 65 00	i p s S of Semiconductors
	-	70 00 73 00 20 00 53 00 65 00	p s S of Semiconductors
	-	73 00 20 00 53 00 65 00	s S of Semiconductors
	-	20 00 53 00 65 00	S of Semiconductors
	- - - -	53 00 65 00	-
	-	65 00	-
	-		e
	-	00 00	
	-		
		69 00	
	-	63 00	C
	-	6F 00	0
	-	6E 00	n
	-	64 00	d
	-	75 00	
	-	63 00	C
	-	74 00	t
	-	6F 00	0
	-	72 00	r
	-	73 00	S
iptor Index 2 (il	Product)		
ength	-	10	string descriptor length (product ID)
escriptorType	-	03 ^[2]	STRING
tring	-	49 00	I of ISP1520
	-	53 00	S
	-	50 00	P
	-	31 00	1
	-	35 00	5
	-	32 00	2
	-	30 00	0
intor Index 3 (if			
· · · · · ·	string mu		
upported, this	-		string descriptor length (serial number)
upported, this songth	-		STRING 9 of 947337877678 = wired support
	pported, this	- - otor Index 3 (iSerialNum pported, this string mus ngth	- 35 00 - 32 00 - 30 00 ptor Index 3 (iSerialNumber) pported, this string must be unique ngth - - 3A escriptorType -

Table 13: ROM or EEPROM detailed map...continued

Table 13	: ROM or EEPROI	M detailed	l mapcom	tinued
	s Content	Default	-	Comment
(Hex)		(Hex)	(Hex)	
52 53		-	34 00	4
54 55		-	37 00	7
56 57		-	33 00	3
58 59		-	33 00	3
5A 5B		-	37 00	7
5C 5D		-	38 00	8
5E 5F		-	37 00	7
60 61		-	37 00	7
62 63		-	36 00	6
64 65		-	37 00	7
66 67		-	38 00	8
68 69		-	20 00	
6A 6B		-	3D 00	=
6C 6D		-	20 00	
6E 6F		-	77 00	W
70 71		-	69 00	i
72 73		-	72 00	r
74 75		-	65 00	e
76 77		-	64 00	d
78 79		-	20 00	
7A 7B		-	73 00	S
7C 7D		-	75 00	u
7E 7F		-	70 00	р
80 81		-	70 00	р
82 83		-	6F 00	0
84 85		-	72 00	r
86 87		-	74 00	t
String d	escriptor Index 1 (i	Manufact	urer) secor	nd language
88	bLength	-	2E	string descriptor length (manufacturer ID)
89	bDescriptorType	-	03[2]	STRING
8A 8B	bString	-	50 00	P of Philips
8C 8D		-	68 00	h
8E 8F		-	69 00	- i
90 91		-	6C 00	-
92 93		-	69 00	_` i
94 95		-	70 00	p
96 97		-	73 00	_「 S
98 99		-	20 00	-
9A 9B		-	53 00	S of Semiconductors
9C 9D		-	65 00	e
				-

	Content		-	Comment
(Hex)		(Hex)	(Hex)	
9E 9F		-	6D 00	m
A0 A1		-	69 00	i
A2 A3		-	63 00	С
A4 A5		-	6F 00	0
A6 A7		-	6E 00	n
A8 A9		-	64 00	d
AA AB		-	75 00	u
AC AD		-	63 00	с
AE AF		-	74 00	t
B0 B1		-	6F 00	0
B2 B3		-	72 00	r
B4 B5		-	73 00	S
String de	scriptor Index 2 (i	Product)		
B6	bLength	-	10 ^[1]	string descriptors (product ID)
B7	bDescriptorType	-	03 ^[2]	STRING
B8 B9	bString	-	49 00	I of ISP1520
BA BB		-	53 00	S
BC BD		-	50 00	Р
BE BF		-	31 00	1
C0 C1		-	35 00	5
C2 C3		-	32 00	2
C4 C5		-	30 00	0
String de	scriptor Index 3 (i	SerialNun	nber)	
C6	bLength	-	16 ^[1]	string descriptors (serial number)
C7	bDescriptorType	-	03 ^[2]	STRING
C8 C9	bString	-	36 00	6 of 6568824022
CA CB		-	35 00	5
CC CD		-	36 00	6
CE CF		-	38 00	8
D0 D1		-	38 00	8
D2 D3		-	32 00	2
D4 D5		-	34 00	4
D6 D7		-	30 00	0
D8 D9		-	32 00	2
DA DB		-	32 00	2
DC DD		-	FF FF	
DE DF		-	FF FF	
E0 E1		-	FF FF	
E2 E3		-	FF FF	
E4 E5		-	FF FF	

Table 13: ROM or EEPROM detailed map...continued

Address (Hex)	Content	Default (Hex)	Example (Hex)	Comment
E6 E7		-	FF FF	
E8 E9		-	FF FF	
EA EB		-	FF FF	
EC ED		-	FF FF	
EE EF		-	FF FF	
F0 F1		-	FF FF	
F2 F3		-	FF FF	
F4 F5		-	FF FF	
F6 F7		-	FF FF	
F8 F9		-	FF FF	
FA FB		-	FF FF	
FC FD		-	FF FF	
FE		-	FF	
FF		-	FF	upper boundary of all string descriptors

Table 13: ROM or EEPROM detailed map...continued

[1] If this string descriptor is not supported, this bLength field must be programmed with the value 02H.

[2] If this string descriptor is not supported, this bDescriptorType field must be used (programmed with any value, for example, 03H).

[3] String descriptor index (iManufacturer) starts from the address 0EH for one language ID support and 10H for two languages ID support.

10. Hub controller description

Each USB device is composed of several independent logic endpoints. An endpoint acts as a terminus of communication flow between the host and the device. At design time, each endpoint is assigned a unique number (endpoint identifier; see Table 14). The combination of the device address (given by the host during enumeration), the endpoint number and the transfer direction allows each endpoint to be uniquely referenced.

The ISP1520 has two endpoints: endpoint 0 (control) and endpoint 1 (interrupt).

Table 14: Hub endpoints								
Function	Endpoint identifier	Transfer type	Direction ^[1]	Maximum packet size (bytes)				
Hub ports 0 to 4	0	control	OUT	64				
			IN	64				
	1	interrupt	IN	1				

[1] IN: input for the USB host; OUT: output from the USB host.

10.1 Endpoint 0

According to the USB specification, all devices must implement a default control endpoint. This endpoint is used by the host to configure the USB device. It provides access to the device configuration and allows generic USB status and control access.

The ISP1520 supports the following descriptor information through its control endpoint 0:

- Device descriptor
- Device_qualifier descriptor
- Configuration descriptor
- Interface descriptor
- Endpoint descriptor
- Hub descriptor
- Other_speed_configuration descriptor.

The maximum packet size of this endpoint is 64 bytes.

10.2 Endpoint 1

Endpoint 1 can be accessed only after the hub has been configured by the host (by sending the Set Configuration command). It is used by the ISP1520 to send the status change information to the host.

Endpoint 1 is an interrupt endpoint. The host polls this endpoint once every 255 ms. After the hub is configured, an IN token is sent by the host to request the port change status. If the hub detects no change in the port status, it returns a NAK to this request, otherwise the Status Change byte is sent. Table 15 shows the content of the change byte.

Bit	Name	Value	Description
0	Hub Status Change		no change in the hub status
		1	change in the hub status detected
1 to 4 Port n Status Change		0	no change in the status of port n (n = 1 to 4)
		1	change in the status of port n (n = 1 to 4)
5 to 7	-	-	not used

Table 15: Status Change byte: bit allocation

11. Descriptors

The ISP1520 hub controller supports the following standard USB descriptors:

- Device
- Device_qualifier
- Other_speed_configuration
- Configuration
- Interface
- Endpoint
- Hub.

The hub returns different descriptors based on the mode of operation: full-speed or high-speed.

Table 16: Device descriptor

Offset	Field name	d name Value (Hex)		Comments	
(bytes)		Full-speed	High-speed		
0	bLength	12	12	descriptor length = 18 bytes	
1	bDescriptorType	01	01	type = DEVICE	
2	bcdUSB	00	00	see USB specification Rev. 2.0	
3		02	02		
4	bDeviceClass	09	09	HUB_CLASSCODE	
5	bDeviceSubClass	00	00	HubSubClassCode	
6	bDeviceProtocol	00	01	HubProtocolHSpeedOneTT	
7	bMaxPacketSize0	40	40	packet size = 64 bytes	
8	idVendor	CC	CC	Philips Semiconductors vendor ID (04CC); can be	
9		04	04	customized	
10	idProduct	20	20	the ISP1520 product ID; can be customized	
11		15	15		
12	bcdDevice	00	00	device ID; can be customized	
13		02	02		
14	iManufacturer	01	01	can be customized	
15	iProduct	02	02	can be customized	
16	iSerialNumber	03	03	can be customized; this value must be unique	
17	bNumConfigurations	01	01	one configuration	

Table 17: Device_qualifier descriptor

Offset	Field name	Value (Hex)		Comments
(bytes)		Full-speed	High-speed	
0	bLength	0A	0A	descriptor length = 10 bytes
1	bDescriptorType	06	06	type = DeviceQualifierType
2	bcdUSB	00	00	see USB specification Rev. 2.0
3	_	02	02	
4	bDeviceClass	09	09	HUB_CLASSCODE
5	bDeviceSubClass	00	00	HubSubClassCode
6	bDeviceProtocol	00	01	HubProtocolHSpeedOneTT
7	bMaxPacketSize0	40	40	packet size = 64 bytes
8	bNumConfigurations	01	01	number of configurations

Table 18: Other_speed_configuration descriptor

Offset	Field name	Value (Hex)		Comments
(bytes)		Full-speed	High-speed	
0	bLength	09	09	descriptor length = 9 bytes
1	bDescriptorType	07	07	type = OtherSpeedConfigurationType
2	wTotalLength	19	19	TotalConfBtye
3		00	00	
4	bNumInterfaces	01	01	-
5	bConfigurationValue	01	01	-
6	iConfiguration	00	00	no string supported
7	bmAttributes	E0	E0	self-powered or hybrid-powered
		A0	A0	others
8	bMaxPower	00	00	self-powered
		32	32	bus-powered and hybrid-powered

Table 19: Configuration descriptor

Offset	Field name	Value (Hex)		Comments
(bytes)		Full-speed	High-speed	
0	bLength	09	09	descriptor length = 9 bytes
1	bDescriptorType	02	02	type = CONFIGURATION
2	wTotalLength	19	19	total length of configuration, interface and endpoint
3		00	00	descriptors = 25 bytes
4	bNumInterfaces	01	01	one interface
5	bConfigurationValue	01	01	configuration value = 1
6	iConfiguration	00	00	no configuration string descriptor
7	bmAttributes	E0	E0	self-powered or hybrid-powered ^[1]
		A0	A0	bus-powered ^[1]
8	bMaxPower ^[2]	00	00	self-powered
		32	32	bus-powered and hybrid-powered

[1] Selected by input pin SP/BP.

9397 750 10689

[2] Value in units of 2 mA.

Table 20: Interface descriptor

Offset	Field name	Value (Hex)		Comments	
(bytes)		Full-speed	High-speed		
0	bLength	09	09	descriptor length = 9 bytes	
1	bDescriptorType	04	04	type = INTERFACE	
2	bInterfaceNumber	00	00	-	
3	bAlternateSetting	00	00	no alternate setting	
4	bNumEndpoints	01	01	status change (interrupt) endpoint	
5	bInterfaceClass	09	09	HUB_CLASSCODE	
6	bInterfaceSubClass	00	00	HubSubClassCode	
7	bInterfaceProtocol	00	00	-	
8	bInterface	00	00	no interface string descriptor	

Table 21: Endpoint descriptor

Offset	Field name	Value (Hex)		Comments		
(bytes)		Full-speed	High-speed			
0	bLength	07	07	descriptor length = 7 bytes		
1	bDescriptorType	05	05	type = ENDPOINT		
2	bEndpointAddress	81	81	endpoint 1 at the address number 1		
3	bmAttributes	03	03	interrupt endpoint		
4	wMaxPacketSize	01	01	packet size = 1 byte		
5		00	00			
6	bInterval	FF	0C	polling interval		

Table 22: Hub descriptor

Offset	Field name	Value (Hex)		Comments	
(bytes)		Full-speed	High-speed		
0	bDescLength	09	09	descriptor length = 9 bytes	
1	bDescriptorType	29	29	type = HUB	
2	bNbrPorts	04	04	number of enabled downstream facing ports; selectable by	
		03 03 DP/DM strapping	DP/DM strapping		
		02	02		
3	wHubCharacteristics	A9	A9	see Table 23	
4		00	00		
5	bPwrOn2PwrGood ^[1]	32	32	ganged or individual mode = 100 ms	
6	bHubContrCurrent	64	64	-	
7	DeviceRemovable	00	00	four downstream facing ports, no embedded port	
8	PortPwrCtrlMask	FF	FF	-	

[1] Value in units of 2 ms.

Table 23:	WHubCharacteristics bit description				
Bit	Function	Value	Description		
D0, D1	logical power switching mode	00	ganged		
		01	individual and multiple ganged		
		11	-		
D2	compound hub selection	0	non-compound		
		1	compound		
D3, D4	overcurrent protection mode	00	global		
		01	individual and multiple ganged		
		10	none		
		11	-		
D5	-				
D6	-				
D7	port indicator	0	global feature		
		1	-		

Table 23: WHubCharacteristics bit description

12. Hub requests

The hub must react to a variety of requests initiated by the host. Some requests are standard and are implemented by any USB device whereas others are hub-class specific requests.

12.1 Standard USB requests

Table 24 shows the supported standard USB requests.

	· · ·					
Request	bmRequestType byte 0 (bits 7 to 0)	bRequest byte 1 (hex)	wValue byte 2, 3 (hex)	wIndex byte 4, 5 (hex)	wLength byte 6, 7 (hex)	Data response
Address						
Set Address	0000 0000	05	device address ^[1]	00, 00	00, 00	none
Configuration						
Get Configuration	1000 0000	08	00, 00	00, 00	01, 00	configuration value
Set Configuration (0)	0000 0000	09	00, 00	00, 00	00, 00	none
Set Configuration (1)	0000 0000	09	01, 00	00, 00	00, 00	none
Descriptors						
Get Configuration Descriptor	1000 0000	06	00, 02	00, 00	length ^[2]	configuration interface and endpoint descriptors
Get Device Descriptor	1000 0000	06	00, 01	00, 00	length ^[2]	device descriptor
Get String Descriptor (0)	1000 0000	06	03, 00	00, 00	length ^[2]	language ID descriptor
Get String Descriptor (1)	1000 0000	06	03, 01	00, 00	length ^[2]	manufacturer string
Get String Descriptor (2)	1000 0000	06	03, 02	00, 00	length ^[2]	product string
Get String Descriptor (3)	1000 0000	06	03, 03	00, 00	length ^[2]	serial number string
Feature						
Clear Device Feature (Remote_ Wakeup)	0000 0000	01	01, 00	00, 00	00, 00	none
Clear Endpoint (1) Feature (Halt/Stall)	0000 0010	01	00, 00	81, 00	00, 00	none
Set Device Feature (Remote_ Wakeup)	0000 0000	03	01, 00	00, 00	00, 00	none
Set Endpoint (1) Feature (Halt/Stall)	0000 0010	03	00, 00	81, 00	00, 00	none
Status						
Get Device Status	1000 0000	00	00, 00	00, 00	02, 00	device status
Get Interface Status	1000 0001	00	00, 00	00, 00	02, 00	zero
Get Endpoint (0) Status	1000 0010	00	00, 00	00/80, 00 <mark>[3]</mark>	02, 00	endpoint 0 status
Get Endpoint (1) Status	1000 0010	00	00, 00	81, 00	02, 00	endpoint 1 status

Table 24: Standard USB requests

[1] Device address: 0 to 127.

[2] Returned value in bytes.

[3] MSB specifies endpoint direction: 0 = OUT, 1 = IN. The ISP1520 accepts either value.

12.2 Hub class requests

Table 25 shows the hub class requests.

Table 25: Hub class re	equests					
Request	bmRequestType byte 0 (bits 7 to 0)	bRequest byte 1 (hex)	wValue byte 2, 3 (hex)	windex byte 4, 5 (hex)	wLength byte 6, 7 (hex)	Data
Descriptor						
Get Hub Descriptor	1010 0000	06	descriptor type and index	00, 00	length ^[2]	descriptor
Feature						
Clear Hub Feature (C_LOCAL_POWER)	0010 0000	01	00, 00	00, 00	00, 00	none
Clear Port Feature	0010 0011	01	feature ^[3] , 00	port ^[4] , 00	00, 00	none
Set Port Feature	0010 0011	03	feature ^[3] , 00	port ^[4] , 00	00, 00	none
Status						
Get Hub Status	1010 0000	00	00, 00	00, 00	04, 00	hub status and change status
Get Port Status	1010 0011	00	00, 00	port ^[4] , 00	04, 00	port status and change status
тт						
ClearTTBuffer	0010 0011	08	Dev_Addr, EP_nr	01, 00	00, 00	none
ResetTT	0010 0000	09	00, 00	01, 00	00, 00	none
GetTTState	1010 0011	10	TT-flags	01, 00	_[1]	TT state
StopTT	0010 0011	11	00, 00	01, 00	00, 00	none
Test modes						
Test_J	0010 0011	03	15, 00	port ^[4] , 01	00, 00	none
Test_K	0010 0011	03	15, 00	port ^[4] , 02	00, 00	none
Test_SE0_NAK	0010 0011	03	15, 00	port ^[4] , 03	00, 00	none
Test_Packet	0010 0011	03	15, 00	port ^[4] , 04	00, 00	none
Test_Force_Enable	0010 0011	03	15, 00	port ^[4] , 05	00, 00	none

[1] Returns vendor-specific data.

[2] Returned value in bytes.

[3] Feature selector value; see Table 26.

[4] Downstream port identifier: 1 to N with N is number of enabled ports (2 to 4).

Feature selector name	Recipient	Value
C_HUB_LOCAL_POWER	hub	00
C_HUB_OVER_CURRENT	hub	01
PORT_CONNECTION	port	00
PORT_ENABLE	port	01
PORT_SUSPEND	port	02
PORT_OVER_CURRENT	port	03
PORT_RESET	port	04
PORT_POWER	port	08
PORT_LOW_SPEED	port	09
C_PORT_CONNECTION	port	16
C_PORT_ENABLE	port	17
C_PORT_SUSPEND	port	18
C_PORT_OVER_CURRENT	port	19
C_PORT_RESET	port	20
PORT_TEST	port	21
PORT_INDICATOR	port	22

Table 26: Hub class feature selector

12.3 Detailed responses to hub requests

12.3.1 Get configuration

This request returns the configuration value of the device. This request returns one byte of data; see Table 27.

Table 27: Get hub configuration response

Bit	Function	Value	Description
0	configuration value	0	device is not configured
		1	device is configured
1 to 7	reserved	0	-

12.3.2 Get device status

This request returns two bytes of data; see Table 28.

Table 28: Get	device	status	response
---------------	--------	--------	----------

Bit	Function	Value	Description	
0	self-powered	0	bus-powered	
		1	self-powered	
1	remote wake-up	0	disabled	
		1	enabled	
2 to 15	reserved	0	-	

12.3.3 Get interface status

The request returns two bytes of data; see Table 29.

Table 29:	Get interface status response				
Bit	Function	Value	Description		
0 to 15	reserved	0	-		

12.3.4 Get endpoint status

The request returns two bytes of data; see Table 30.

Table 30:	Get endpoint status response				
Bit	Function	Value	Description		
0	halt	0	endpoint is not halted		
		1	endpoint is halted		
1 to 15	reserved	0	-		

12.3.5 Get hub status

The request returns four bytes of data; see Table 31.

Table 31:	Get hub sta	tus response
-----------	-------------	--------------

Bit	Function	Value	Description
0	local power source	0	local power supply good
		1	local power supply lost (inactive)
1	overcurrent indicator	0	no overcurrent condition currently exists
		1	a hub overcurrent condition exists
2 to 15	reserved	0	-
16	local power status change	0	no change in the local power status
		1	local power status has changed
17	overcurrent indicator change	0	no change in overcurrent
		1	overcurrent status has changed
18 to 31	reserved	0	-

12.3.6 Get port status

This request returns four bytes of data. The first word contains the port status bits (wPortStatus), and the next word contains the port status change bits (wPortChange). The contents of wPortStatus is given in Table 32, and the contents of wPortChange is given in Table 33.

Table 32:	Get port	t status res	ponse	(wPortStatus)
-----------	----------	--------------	-------	---------------

Bit	Function	Value	Description		
0	current connect status	0	no device is present		
		1	a device is present on this port		
1	port enabled or disabled	0	port is disabled		
		1	port is enabled		
2	suspend	0	port is not suspended		
		1	port is suspended		

Bit	Function	Value	Description
3	overcurrent indicator	0	no overcurrent condition exists
		1	an overcurrent condition exists
4	reset	0	reset signaling is not asserted
		1	reset signaling is asserted
5 to 7	reserved	0	-
8	port power	0	port is in the powered-off state
		1	port is not in the powered-off state
9	low-speed device attached	0	full-speed or high-speed device is attached
		1	low-speed device is attached
10	high-speed device attached	0	full-speed device is attached
		1	high-speed device is attached
11	port test mode	0	not in the port test mode
		1	in the port test mode
12	port indicator control	0	displays default colors
		1	displays software controlled color
13 to 15	reserved	0	-

 Table 32:
 Get port status response (wPortStatus)...continued

Table 33: Get port status change response (wPortChange)

Bit	Function	Value	Description
0	connect status change		no change in the current connect status
		1	change in the current connect status
1	port enable or disable change		port is enabled
		1	port is disabled
2	suspend change	0	no change
		1	resume complete
3	overcurrent indicator change	0	no change in the overcurrent indicator
		1	change in the overcurrent indicator
4	reset change	0	no change
		1	reset complete
5 to 15	reserved	0	-

12.4 Various get descriptors

bmRequestType — 10000000B **bmRequest** — GET_DESCRIPTOR = 6

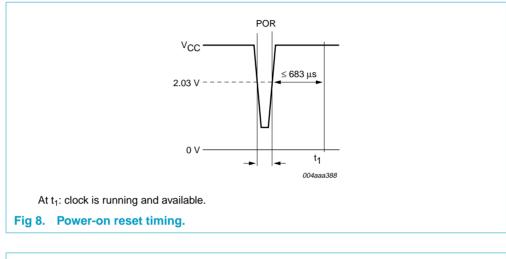
Table 34: Get descriptor request

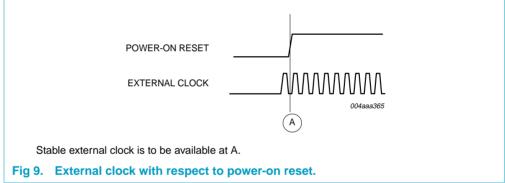
Request name	wValue		wIndex	Data
	Descriptor index	Descriptor type	Zero/Language ID	
Get device descriptor	00	01	0	device descriptor
Get configuration descriptor	00	02	0	configuration interface and endpoint descriptors
Get language ID string descriptor	00	03	0	language ID support string
Get manufacturer string descriptor	01	03	n	manufacturer string in LANGID n
Get product string descriptor	02	03	n	product string in LANGID n
Get serial number string descriptor	03	03	n	serial number string in LANGID n

13. Power-on reset

The ISP1520 has an internal Power-On Reset (POR) circuit.

The triggering voltage of the POR circuit is 2.03 V nominal. A POR is automatically generated when V_{CC} goes below the trigger voltage for a duration longer than 1 μ s.





14. Limiting values

Table 35: Absolute maximum ratings

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage 3.3 V		-0.5	+4.6	V
V _{CC(5V0)}	supply voltage 5.0 V		-0.5	+6.0	V
V _{I(5V0)}	input voltage on 5 V buffers	$3.0 \text{ V} < \text{V}_{\text{CC}} < 3.6 \text{ V}$	[1] -0.5	+6.0	V
V _{I(3V3)}	input voltage on 3.3 V buffers	$3.0 \text{ V} < \text{V}_{\text{CC}} < 3.6 \text{ V}$	-0.5	+4.6	V
V _{O(3V3)}	output voltage on 3.3 V buffers		-0.5	+4.6	V
l _{lu}	latch-up current	$V_{I} < 0 \text{ or } V_{I} > V_{CC}$	-	100	mA
V _{esd}	electrostatic discharge voltage	on pins DM1 to DM4, DP1 to DP4, $\overline{OC1}$ to $\overline{OC4}$, and all V _{CC(5V0)} and GND pins; I _{LI} < 1 μ A	[<mark>2][3]</mark> –4000	+4000	V
		on all other pins; $I_{LI} < 1 \ \mu A$	[2][3] –2000	+2000	V
T _{stg}	storage temperature		-40	+125	°C

[1] Valid only when supply voltage is present.

[2] Test method available on request.

[3] Equivalent to discharging a 100 pF capacitor via a 1.5 k Ω resistor (Human Body Model).

15. Recommended operating conditions

Table 36: Recommended operating ranges

Symbol	Parameter		Min	Тур	Max	Unit
V _{CC}	supply voltage 3.3 V		3.0	3.3	3.6	V
V _{CC(5V0)}	supply voltage 5 V	[1]	4.5	5.0	5.5	V
VI	input voltage on 3.3 V pins		0	-	V _{CC}	V
V _{I(5V0)}	input voltage on 5 V tolerant pins		0	-	V _{CC(5V0)}	V
T _{amb}	operating temperature		-40	-	+85	°C

[1] All internal pull-up resistors are connected to this voltage.

16. Static characteristics

Table 37: Static characteristics: supply pins

 V_{CC} = 3.0 to 3.6 V; T_{amb} = -40 to +85 °C; unless otherwise specified.

00	, unio ,					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Full-spee	ed					
I _{CC(5V0)}	supply current 5 V		-	0.5	-	mA
I _{CC(tot)}	total supply current 3.3 V	$I_{CC(tot)} = I_{CC1} + I_{CC2} + I_{CC3} + I_{CC4}$	[1] _	91	-	mA
High-spe	ed					
I _{CC(5V0)}	supply current 5 V		-	0.5	-	mA
I _{CC(tot)}	total supply current 3.3 V	suspend mode; internal clock stopped	[2][3]	0.5	-	mA
		no device connected; bus-powered mode; ports 3 and 4 disabled	-	120	-	mA
		no device connected	-	136.3	-	mA
		1 active device connected	-	180	-	mA
		2 active devices connected	-	221	-	mA
		3 active devices connected	-	256	-	mA
		4 active devices connected	-	288	-	mA

[1] Irrespective of the number of devices connected, the value of I_{CC} is always 91 mA in full-speed.

[2] Including R_{pu} drop current.

[3] In the bus-powered mode, only two ports are active.

Table 38: Static characteristics: digital input and outputs^[1]

 V_{CC} = 3.0 to 3.6 V; T_{amb} = -40 to +85 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Digital in	put pins					
V _{IL}	LOW-level input voltage		-	-	0.8	V
VIH	HIGH-level input voltage		2.0	-	-	V
I _{LI}	input leakage current		-1	-	+1	μA
Schmitt-t	rigger input pins					
V _{th(LH)}	positive-going threshold voltage		1.4	-	1.9	V
V _{th(HL)}	negative-going threshold voltage		0.9	-	1.5	V
V _{hys}	hysteresis voltage		0.4	-	0.7	V
Overcurr	ent detection pins OC1 to OC4					
ΔV_{trip}	overcurrent detection trip voltage	$\Delta V = V_{CC} - V_{\overline{OCn}}$	[2] _	84	-	mV
Digital ou	utput pins					
V _{OL}	LOW-level output voltage		-	-	0.4	V
V _{OH}	HIGH-level output voltage		2.4	-	-	V
Open-dra	ain output pins					
l _{oz}	OFF-state output current		-1	-	+1	μA

[1] All pins are 5 V tolerant.

[2] Bus-powered mode.

Table 39: Static characteristics: I²C-bus interface block

```
V_{CC} = 3.0 to 3.6 V; T_{amb} = -40 to +85 °C; unless otherwise specified.
```

00	, amb	•				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Input pin	SCL and input/output pin SDA ^[1]					
V _{IL}	LOW-level input voltage		-	-	0.9	V
V _{IH}	HIGH-level input voltage		2.1	-	-	V
V _{hys}	hysteresis voltage		0.15	-	-	V
V _{OL}	LOW-level output voltage		-	-	0.4	V
t _f	output fall time V_{IH} to V_{IL}	$10 < C_b = 10$ to 400 pF	[2] _	0	250	ns

[1] All pins are 5 V tolerant.

[2] The bus capacitance (C_b) is specified in pF. To meet the specification for V_{OL} and the maximum rise time (300 ns), use an external pull-up resistor with R_{max} = 850/C_b k Ω and R_{min} = (V_{CC} - 0.4)/3 k Ω .

Table 40: Static characteristics: USB interface block (DP0 to DP4 and DM0 to DM4)

$V_{22} = 30 to 36$	$V \cdot T = -40$ to	185°C· unlass	otherwise specified.
$v_{CC} = 3.0 10 3.0$	$V, T_{amb} = -40.00$	$\tau 00$ C, unless	onierwise specifieu.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Input leve	els for high-speed						
V _{HSSQ}	squelch detection threshold	squelch detected		-	-	100	mV
	(differential signal amplitude)	no squelch detected		150	-	-	mV
V _{HSCM}	data signaling common-mode voltage range			-50	-	+500	mV
Output le	vels for high-speed						
V _{HSOI}	idle state			-10	-	+10	mV
V _{HSOH}	data signaling HIGH			360	-	440	mV
V _{HSOL}	data signaling LOW			-10	-	+10	mV
V _{CHIRPJ}	Chirp J level (differential voltage)		[1]	700	-	1100	mV
V _{CHIRPK}	Chirp K level (differential voltage)		[1]	-900	-	-500	mV
Input leve	els for full-speed and low-speed						
V _{IL}	LOW-level input voltage			-	-	0.8	V
V _{IH}	HIGH-level input voltage (drive)			2.0	-	-	V
V _{IHZ}	HIGH-level input voltage (floating)			2.7	-	3.6	V
V _{DI}	differential input sensitivity	DP – DM		0.2	-	-	V
V _{CM}	differential common-mode range			0.8	-	2.5	V
Output le	vels for full-speed and low-speed						
V _{OL}	LOW-level output voltage			0	-	0.3	V
V _{OH}	HIGH-level output voltage			2.8	-	3.6	V
V _{CRS}	output signal crossover point voltage		[2]	1.3	-	2.0	V
Leakage	current						
I _{LZ}	OFF-state leakage current			-1	-	+1	μA
Capacita	nce						
C _{IN}	transceiver capacitance	pin to GND		-	-	20	pF

Table 40: Static characteristics: USB interface block (DP0 to DP4 and DM0 to DM4)...continued

 V_{CC} = 3.0 to 3.6 V; T_{amb} = -40 to +85 °C; unless otherwise specified.

	, anno ,	1				
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Resistan	се					
Z _{INP}	input impedance		10	-	-	MΩ
Terminat	ion					
V _{TERM}	termination voltage for pull-up resistor on pin RPU		^[3] 3.0	-	3.6	V

[1] For minimum value the HS termination resistor is disabled and the pull-up resistor is connected. Only during reset, when both the hub and the device are capable of high-speed operation.

[2] Characterized only, not tested. Limits guaranteed by design.

[3] In the suspend mode, the minimum voltage is 2.7 V.

17. Dynamic characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Reset							
t _{W(POR)}	internal power-on reset pulse width			0.2	-	1	μs
$t_{W(\overline{RESET})}$	pulse width on pin RESET			0.2	-	-	μs
Crystal os	scillator						
f _{clk}	clock frequency	crystal	[1][2]	-	12	-	MHz
External of	clock input						
δ	clock duty cycle			-	50	-	%

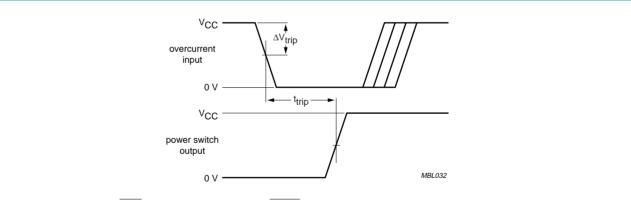
[1] Recommended accuracy of the clock frequency is 500 ppm for the crystal.

[2] Suggested values for external capacitors when using a crystal are 22 to 27 pF.

Table 42: Dynamic characteristics: overcurrent sense timing

 V_{CC} = 3.0 to 3.6 V; T_{amb} = -40 to +85 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Overcurre	ent sense pins OC1 to OC4					
t _{trip}	overcurrent trip response time from OCn LOW to PSWn HIGH	see Figure 10	-	-	15	ms



Overcurrent input: pins $\overline{\text{OCn}}$; power switch output: pins $\overline{\text{PSWn}}$.

Reference voltage for overcurrent sensing: V_{CC} for bus-powered mode or $V_{SP/\overline{BP}}$ for self-powered mode.

Fig 10. Overcurrent trip response timing.

Table 43: Dynamic characteristics: digital pins^[1]

 V_{CC} = 3.0 to 3.6 V; T_{amb} = -40 to +85 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _{t(HL)} ,	output transition time		4	-	15	ns
t _{t(LH)}						

[1] All pins are 5 V tolerant.

Table 44: Dynamic characteristics: high-speed source electrical characteristics

V_{CC} = 3.0 to 3.6 V; T_{amb} = -40 to +85 °C; test circuit Figure 25; unless otherwise specified.

			,			
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Driver ch	aracteristics					
t _{HSR}	rise time	10% to 90%	500	-	-	ps
t _{HSF}	fall time	90% to 10%	500	-	-	ps
Clock tim	ling					
t _{HSDRAT}	data rate		479.76	-	480.24	Mbit/s
t _{HSFRAM}	microframe interval		124.9375	5 -	125.0625	μs
t _{HSRFI}	consecutive microframe interval difference		1	-	four high-speed bit times	ns

Table 45: Dynamic characteristics: full-speed source electrical characteristics

 V_{CC} = 3.0 to 3.6 V; T_{amb} = -40 to +85 °C; test circuit Figure 26; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Driver ch	aracteristics						
t _{FR}	rise time	C_{L} = 50 pF; 10% to 90% of $ V_{OH}-V_{OL} $		4	-	20	ns
t _{FF}	fall time	C_{L} = 50 pF; 90% to 10% of $ V_{OH}-V_{OL} $		4	-	20	ns
t _{FRFM}	differential rise and fall time matching		[1]	90	-	111.1	%
Z _{DRV}	driver output resistance	for the driver that is not high-speed capable		28	-	44	Ω
V _{CRS}	output signal crossover voltage		[1][2]	1.3	-	2.0	V
Data sou	rce timing ^[2]						
t _{DJ1}	source differential jitter for consecutive transitions	see Figure 11	[1]	-3.5	-	+3.5	ns
t _{DJ2}	source differential jitter for paired transitions	see Figure 11	[1]	-4	-	+4	ns
t _{FEOPT}	source SE0 interval of EOP	see Figure 12		160	-	175	ns
t _{FDEOP}	source differential data-to-EOP transition skew	see Figure 12		-2	-	+5	ns
Receiver	timing ^[2]						
t _{JR1}	receiver data jitter tolerance for consecutive transitions	see Figure 13		-18.5	-	+18.5	ns
t _{JR2}	receiver data jitter tolerance for paired transitions	see Figure 13		-9	-	+9	ns
t _{FEOPR}	receiver SE0 width	accepted as EOP; see Figure 12		82	-	-	ns
t _{FST}	width of SE0 interval during differential transaction	rejected as EOP; see Figure 14		-	-	14	ns

Table 45: Dynamic characteristics: full-speed source electrical characteristics...continued

 $V_{CC} = 3.0$ to 3.6 V; $T_{amb} = -40$ to +85 °C; test circuit Figure 26; unless otherwise specified.

		- · · ·				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Hub timir	ng (downstream ports configured a	s full-speed) ^[2]				
t _{FHDD}	hub differential data delay (without cable)	see Figure 15; C _L = 0 pF	-	-	44	ns
t _{FSOP}	data bit width distortion after SOP	see Figure 15	-5	-	+5	ns
t _{FEOPD}	hub EOP delay relative to t _{HDD}	see Figure 16	0	-	15	ns
t _{FHESK}	hub EOP output width skew	see Figure 16	-15	-	+15	ns

[1] Excluding the first transition from Idle state.

[2] Characterized only, not tested. Limits guaranteed by design.

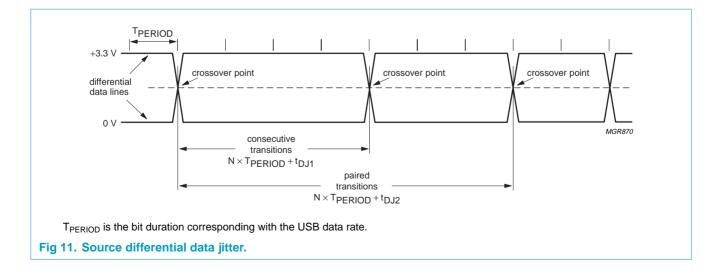
Table 46: Dynamic characteristics: low-speed source electrical characteristics

 V_{CC} = 3.0 to 3.6 V; T_{amb} = -40 to +85 °C; test circuit Figure 26; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Driver ch	aracteristics						
t _{LR}	rise time			75	-	300	ns
t _{LF}	fall time			75	-	300	ns
t _{LRFM}	differential rise and fall time matching		[1]	80	-	125	%
V _{CRS}	output signal crossover voltage		[1][2]	1.3	-	2.0	V
Hub timir	ng (downstream ports configured a	s full-speed)					
t _{LHDD}	hub differential data delay	see Figure 15		-	-	300	ns
t _{LSOP}	data bit width distortion after SOP	see Figure 15	[2]	-60	-	+60	ns
t _{LEOPD}	hub EOP delay relative to t _{HDD}	see Figure 16	[2]	0	-	200	ns
t _{LHESK}	hub EOP output width skew	see Figure 16	[2]	-300	-	+300	ns

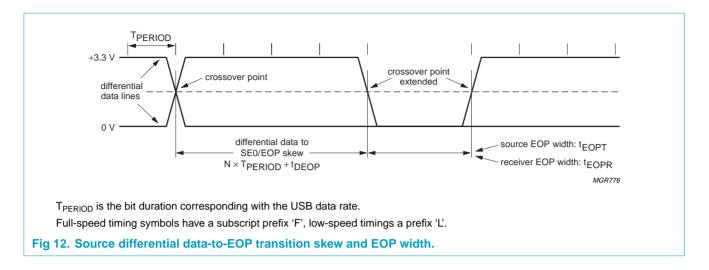
[1] Excluding the first transition from Idle state.

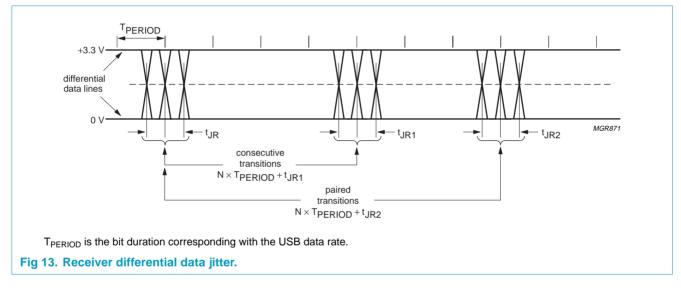
[2] Characterized only, not tested. Limits guaranteed by design.

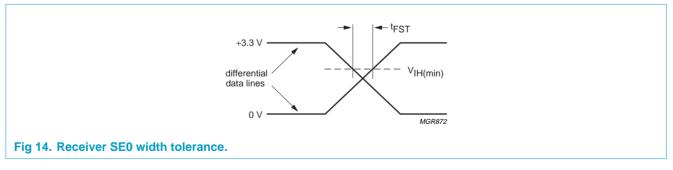


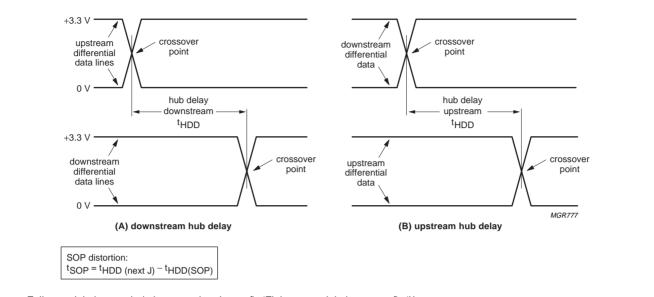
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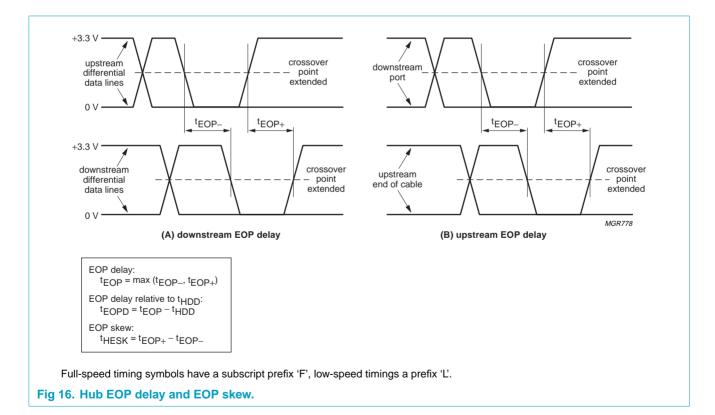






Full-speed timing symbols have a subscript prefix 'F', low-speed timings a prefix 'L'.

Fig 15. Hub differential data delay and SOP distortion.



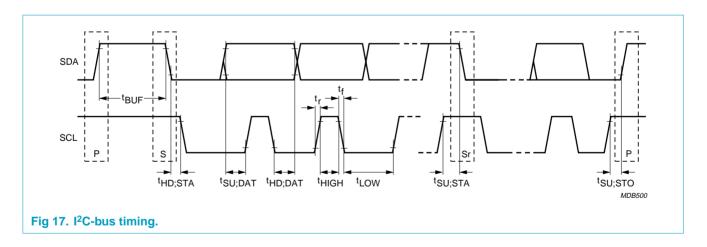
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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Clock fre	quency						
f _{SCL}	SCL clock frequency	$f_{XTAL} = 12 \text{ MHz}$	[1]	0	93.75	100	kHz
General t	iming						
t _{LOW}	SCL LOW time			4.7	-	-	μs
t _{HIGH}	SCL HIGH time			4.0	-	-	μs
t _r	SCL and SDA rise time		[2]	-	-	1000	ns
t _f	SCL and SDA fall time			-	-	300	ns
C _b	capacitive load for each bus line			-	-	400	pF
SDA timi	ng						
t _{BUF}	bus free time			4.7	-	-	μs
t _{SU;STA}	set-up time for (repeated) START condition			4.7	-	-	μs
t _{HD;STA}	hold time (repeated) START condition			4.0	-	-	μs
t _{SU;DAT}	data set-up time			250	-	-	ns
t _{HD;DAT}	data hold time			0	-	-	μs
t _{SU;STO}	set-up time for STOP condition			4.0	-	-	μs
Additiona	al I ² C-bus timing						
t _{VD;DAT}	SCL LOW to data-out valid time			-	-	0.4	μs

Т

 $f_{SCL} = \frac{1}{64} \times f_{XTAL}$. [1]

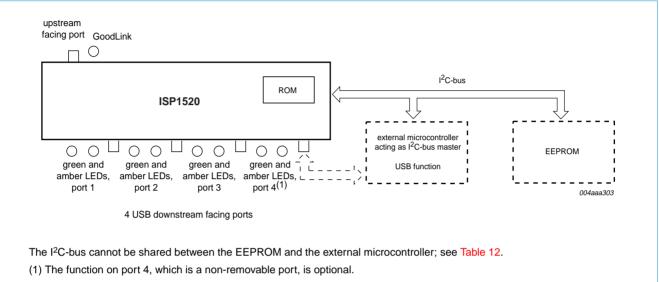
Rise time is determined by C_b and pull-up resistor value R_p (typical 4.7 k Ω). [2]



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18. Application information



18.1 Descriptor configuration selection

Fig 18. Descriptors configuration selection application diagram.

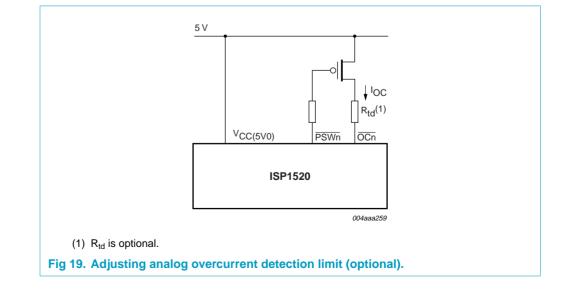
18.2 Overcurrent detection limit adjustment

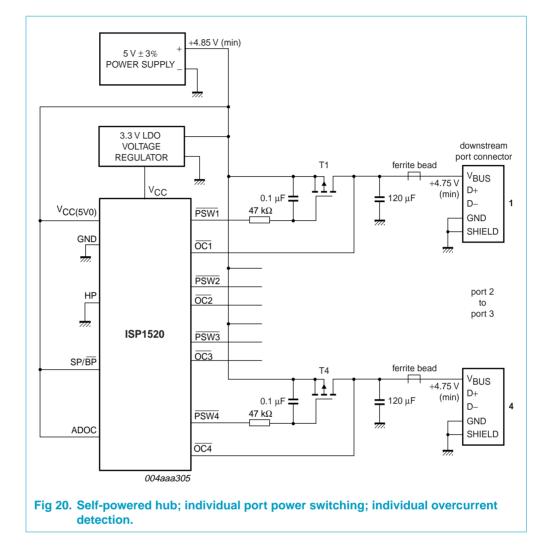
For an overcurrent limit of 500 mA per port, a PMOS with R_{DSON} of approximately 100 m Ω is required. If a PMOS with a lower R_{DSON} is used, analog overcurrent detection can be adjusted by using a series resistor; see Figure 19.

 $\Delta V_{PMOS} = \Delta V_{trip} = \Delta V_{trip(intrinsic)} - (I_{OC(nom)} \times R_{td})$, where:

 ΔV_{PMOS} = voltage drop on PMOS

 $I_{OC(nom)} = 0.6 \ \mu A.$

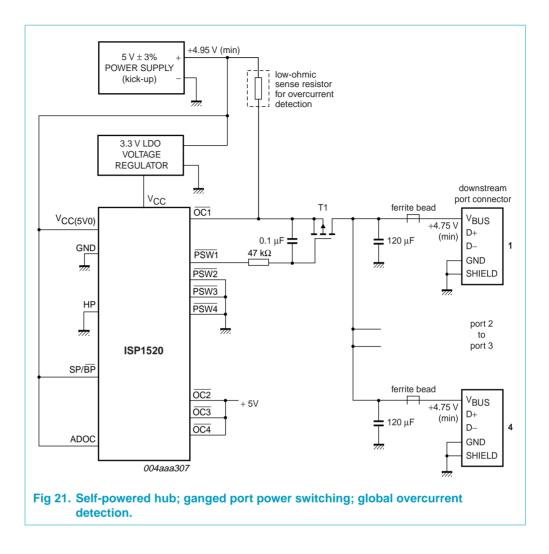


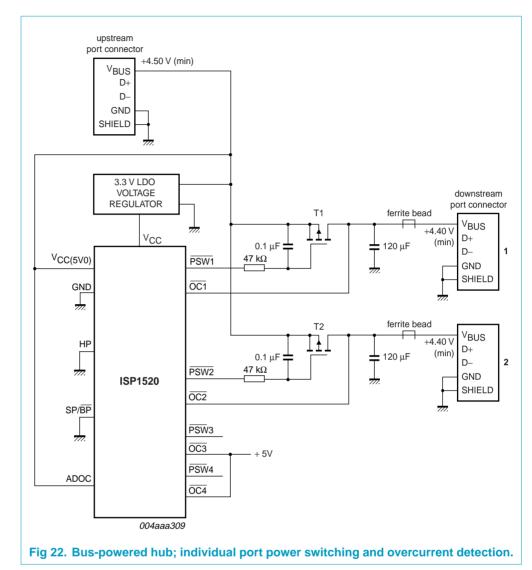


18.3 Self-powered hub configurations

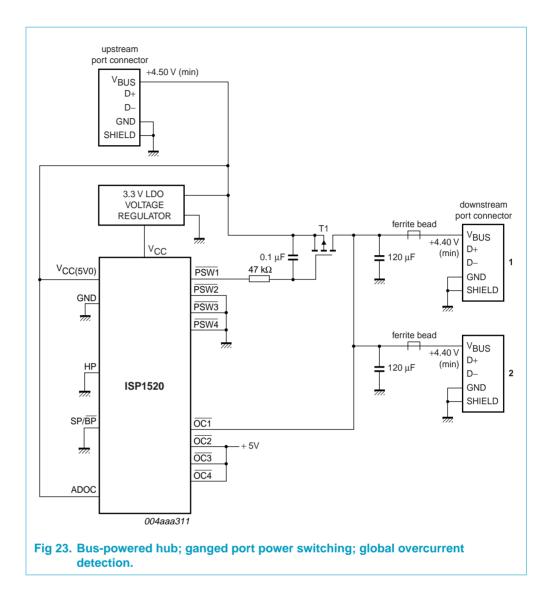
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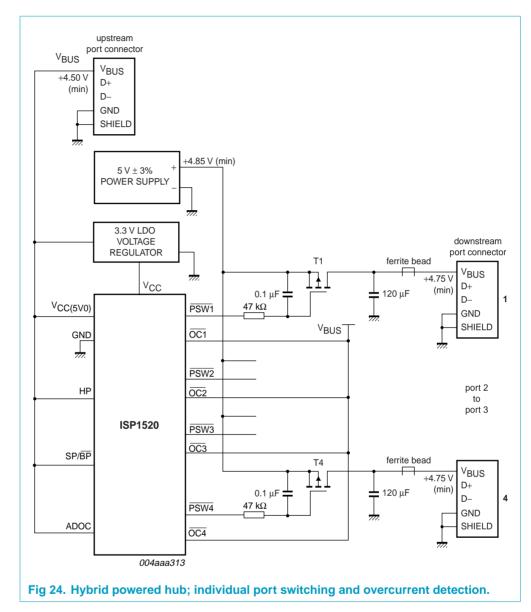
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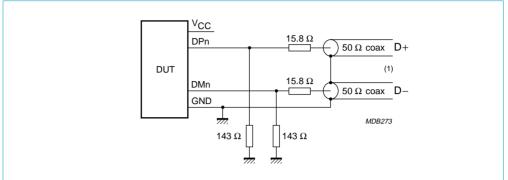
18.4 Bus-powered configurations





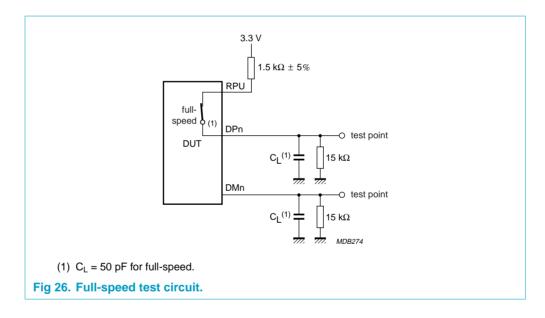
18.5 Hybrid-powered configuration

19. Test information



(1) Transmitter: connected to 50 Ω inputs of a high-speed differential oscilloscope. Receiver: connected to 50 Ω outputs of a high-speed differential data generator.





20. Package outline

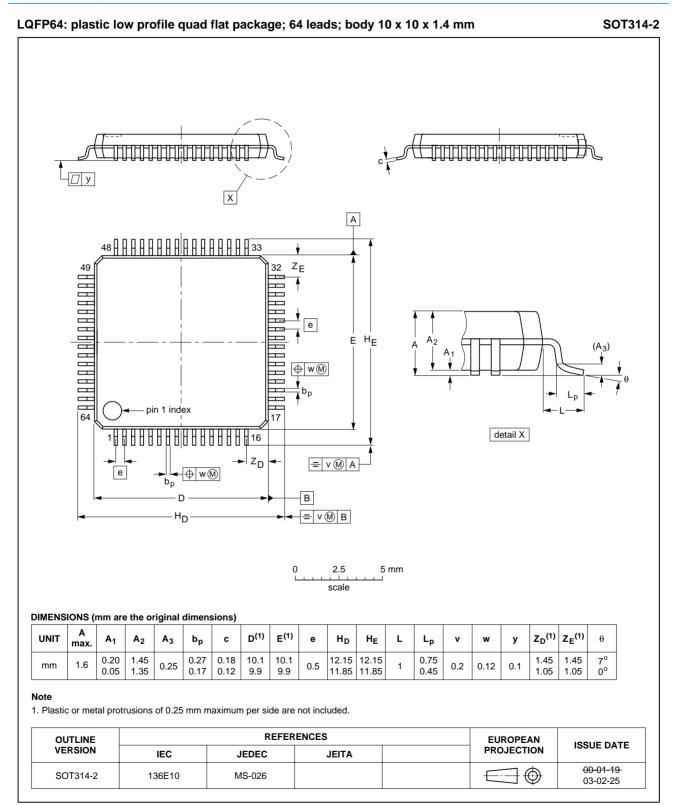


Fig 27. LQFP64 package outline.

21. Soldering

21.1 Introduction to soldering surface mount packages

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our *Data Handbook IC26; Integrated Circuit Packages* (document order number 9398 652 90011).

There is no soldering method that is ideal for all IC packages. Wave soldering can still be used for certain surface mount ICs, but it is not suitable for fine pitch SMDs. In these situations reflow soldering is recommended. In these situations reflow soldering is recommended.

21.2 Reflow soldering

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement. Driven by legislation and environmental forces the worldwide use of lead-free solder pastes is increasing.

Several methods exist for reflowing; for example, convection or convection/infrared heating in a conveyor type oven. Throughput times (preheating, soldering and cooling) vary between 100 and 200 seconds depending on heating method.

Typical reflow peak temperatures range from 215 to 270 °C depending on solder paste material. The top-surface temperature of the packages should preferably be kept:

- below 220 °C (SnPb process) or below 245 °C (Pb-free process)
 - for all BGA and SSOP-T packages
 - for packages with a thickness $\geq 2.5~\text{mm}$
 - for packages with a thickness < 2.5 mm and a volume ≥ 350 mm³ so called thick/large packages.
- below 235 °C (SnPb process) or below 260 °C (Pb-free process) for packages with a thickness < 2.5 mm and a volume < 350 mm³ so called small/thin packages.

Moisture sensitivity precautions, as indicated on packing, must be respected at all times.

21.3 Wave soldering

Conventional single wave soldering is not recommended for surface mount devices (SMDs) or printed-circuit boards with a high component density, as solder bridging and non-wetting can present major problems.

To overcome these problems the double-wave soldering method was specifically developed.

If wave soldering is used the following conditions must be observed for optimal results:

• Use a double-wave soldering method comprising a turbulent wave with high upward pressure followed by a smooth laminar wave.

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- For packages with leads on two sides and a pitch (e):
 - larger than or equal to 1.27 mm, the footprint longitudinal axis is preferred to be parallel to the transport direction of the printed-circuit board;
 - smaller than 1.27 mm, the footprint longitudinal axis **must** be parallel to the transport direction of the printed-circuit board.

The footprint must incorporate solder thieves at the downstream end.

• For packages with leads on four sides, the footprint must be placed at a 45° angle to the transport direction of the printed-circuit board. The footprint must incorporate solder thieves downstream and at the side corners.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Typical dwell time of the leads in the wave ranges from 3 to 4 seconds at 250 °C or 265 °C, depending on solder material applied, SnPb or Pb-free respectively.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

21.4 Manual soldering

Fix the component by first soldering two diagonally-opposite end leads. Use a low voltage (24 V or less) soldering iron applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to $300 \,^{\circ}$ C.

When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 $^\circ$ C.

21.5 Package related soldering information

Table 48:	Suitability of surface mount IC packages for wave and reflow soldering
	methods

Package ^[1]	Soldering method		
	Wave	Reflow ^[2]	
BGA, LBGA, LFBGA, SQFP, SSOP-T ^[3] , TFBGA, VFBGA	not suitable	suitable	
DHVQFN, HBCC, HBGA, HLQFP, HSQFP, HSOP, HTQFP, HTSSOP, HVQFN, HVSON, SMS	not suitable ^[4]	suitable	
PLCC ^[5] , SO, SOJ	suitable	suitable	
LQFP, QFP, TQFP	not recommended ^{[5][6]}	suitable	
SSOP, TSSOP, VSO, VSSOP	not recommended ^[7]	suitable	

[1] For more detailed information on the BGA packages refer to the *(LF)BGA Application Note* (AN01026); order a copy from your Philips Semiconductors sales office.

[2] All surface mount (SMD) packages are moisture sensitive. Depending upon the moisture content, the maximum temperature (with respect to time) and body size of the package, there is a risk that internal or external package cracks may occur due to vaporization of the moisture in them (the so called popcorn effect). For details, refer to the Drypack information in the Data Handbook IC26; Integrated Circuit Packages; Section: Packing Methods.

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- [3] These transparent plastic packages are extremely sensitive to reflow soldering conditions and must on no account be processed through more than one soldering cycle or subjected to infrared reflow soldering with peak temperature exceeding 217 °C ± 10 °C measured in the atmosphere of the reflow oven. The package body peak temperature must be kept as low as possible.
- [4] These packages are not suitable for wave soldering. On versions with the heatsink on the bottom side, the solder cannot penetrate between the printed-circuit board and the heatsink. On versions with the heatsink on the top side, the solder might be deposited on the heatsink surface.
- [5] If wave soldering is considered, then the package must be placed at a 45° angle to the solder wave direction. The package footprint must incorporate solder thieves downstream and at the side corners.
- [6] Wave soldering is suitable for LQFP, QFP and TQFP packages with a pitch (e) larger than 0.8 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.65 mm.
- [7] Wave soldering is suitable for SSOP and TSSOP packages with a pitch (e) equal to or larger than 0.65 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.5 mm.

22. Revision history

Table 49: Revision history

Rev	Date	CPCN	Description
01	20030625		Preliminary data (9397 750 10689)

23. Data sheet status

Level	Data sheet status ^[1]	Product status ^{[2][3]}	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
111	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

[1] Please consult the most recently issued data sheet before initiating or completing a design.

[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.

[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status

24. Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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Contact information

For additional information, please visit http://www.semiconductors.philips.com. For sales office addresses, send e-mail to: sales.addresses@www.semiconductors.philips.com.

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